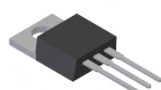


Features

- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Also Available in Green Molding Compound**
 - **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

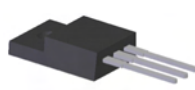
- Case: TO-220AB, ITO-220AB, D²Pak
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: TO-220AB – 1.85 grams (approximate)
ITO-220AB – 1.65 grams (approximate)
D²Pak – 2.1 grams (approximate)



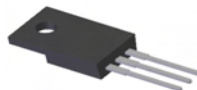
TO-220AB
Top View



TO-220AB
Bottom View



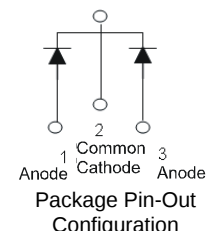
ITO-220AB
Top View



ITO-220AB
Bottom View



D²Pak
Top View

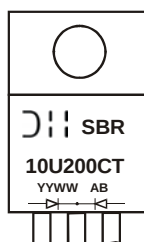


Ordering Information (Notes 4 and 5)

	Part Number	Case	Packaging
	SBR10U200CT	TO-220AB	50 pieces/tube
	SBR10U200CT-G	TO-220AB	50 pieces/tube
	SBR10U200CTFP	ITO-220AB	50 pieces/tube
	SBR10U200CTFP-G	ITO-220AB	50 pieces/tube
	SBR10U200CTFP-JT	ITO-220AB (Alternate)	50 pieces/tube
	SBR10U200CTB	D ² Pak	50 pieces/tube
	SBR10U200CTB-G	D ² Pak	50 pieces/tube
	SBR10U200CTB-13	D ² Pak	800/Tape & Reel
	SBR10U200CTB-13-G	D ² Pak	800/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For Green Molding Compound version part numbers, add "-G" suffix to part number above. Examples: SBR10U200CTB-G.
 5. For packaging details, go to our website at <http://www.diodes.com>.

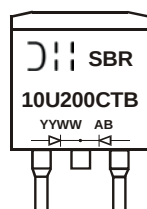
Marking Information



SBR10U200CT = Product Type Marking Code
AB = Foundry and Assembly Code
YYWW = Date Code Marking
YY = Last two digits of year (ex: 06 = 2006)
WW = Week (01 - 53)



SBR10U200CTFP = Product Type Marking Code
AB = Foundry and Assembly Code
YYWW = Date Code Marking
YY = Last two digits of year (ex: 06 = 2006)
WW = Week (01 - 53)



SBR10U200CTB = Product Type Marking Code
AB = Foundry and Assembly Code
YYWW = Date Code Marking
YY = Last two digits of year (ex: 06 = 2006)
WW = Week (01 - 53)

Maximum Ratings (Per Leg) @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	200	V
Average Rectified Output Current (Per Leg) (Total)	I _O	5 10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	150	A
Peak Repetitive Reverse Surge Current (2μS-1KHz)	I _{RRM}	3	A
Isolation Voltage (ITO-220AB Only) From terminal to heatsink t = 3 sec.	V _{AC}	2000	V

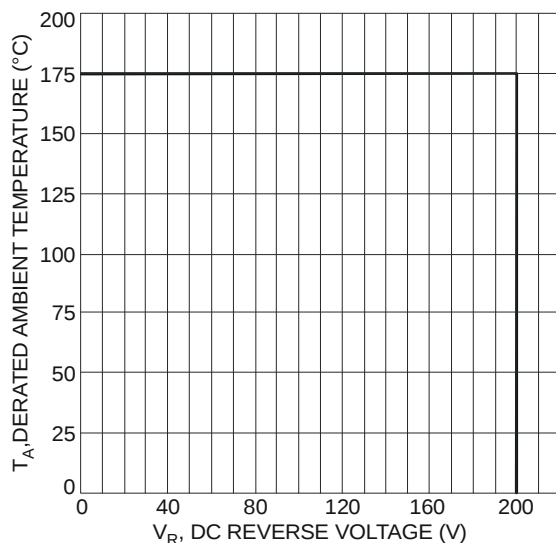
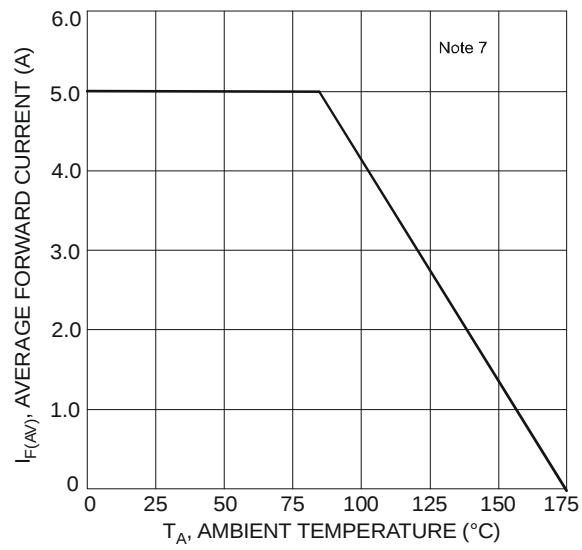
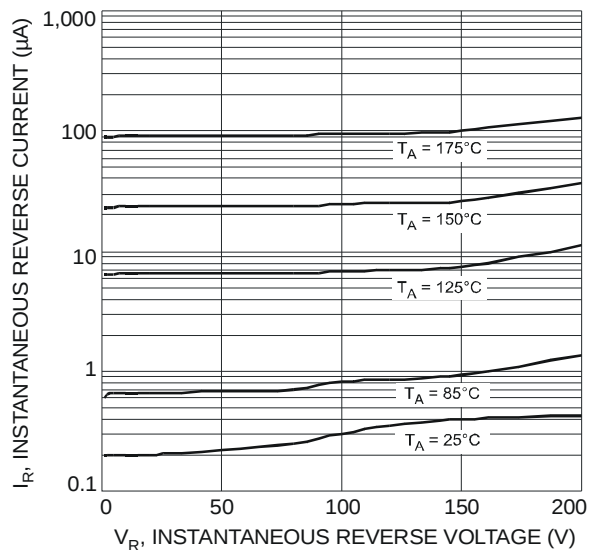
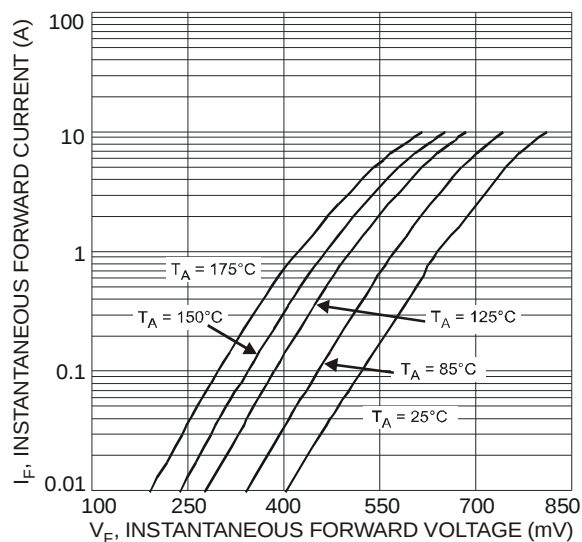
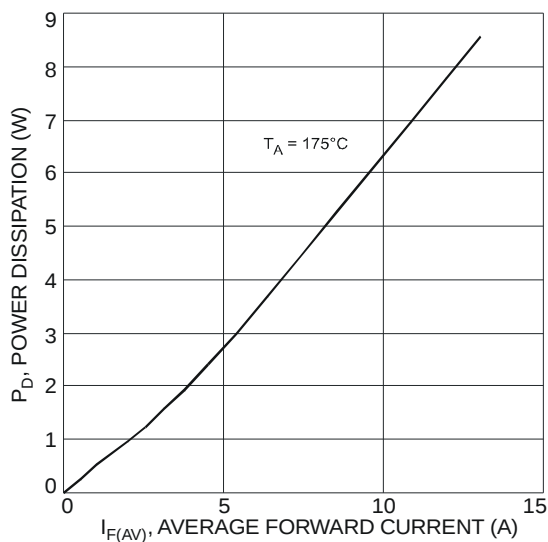
Thermal Characteristics (Per Leg)

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Package = TO-220AB & D ² Pak Package = ITO-220AB	R _{θJC}	2 4	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

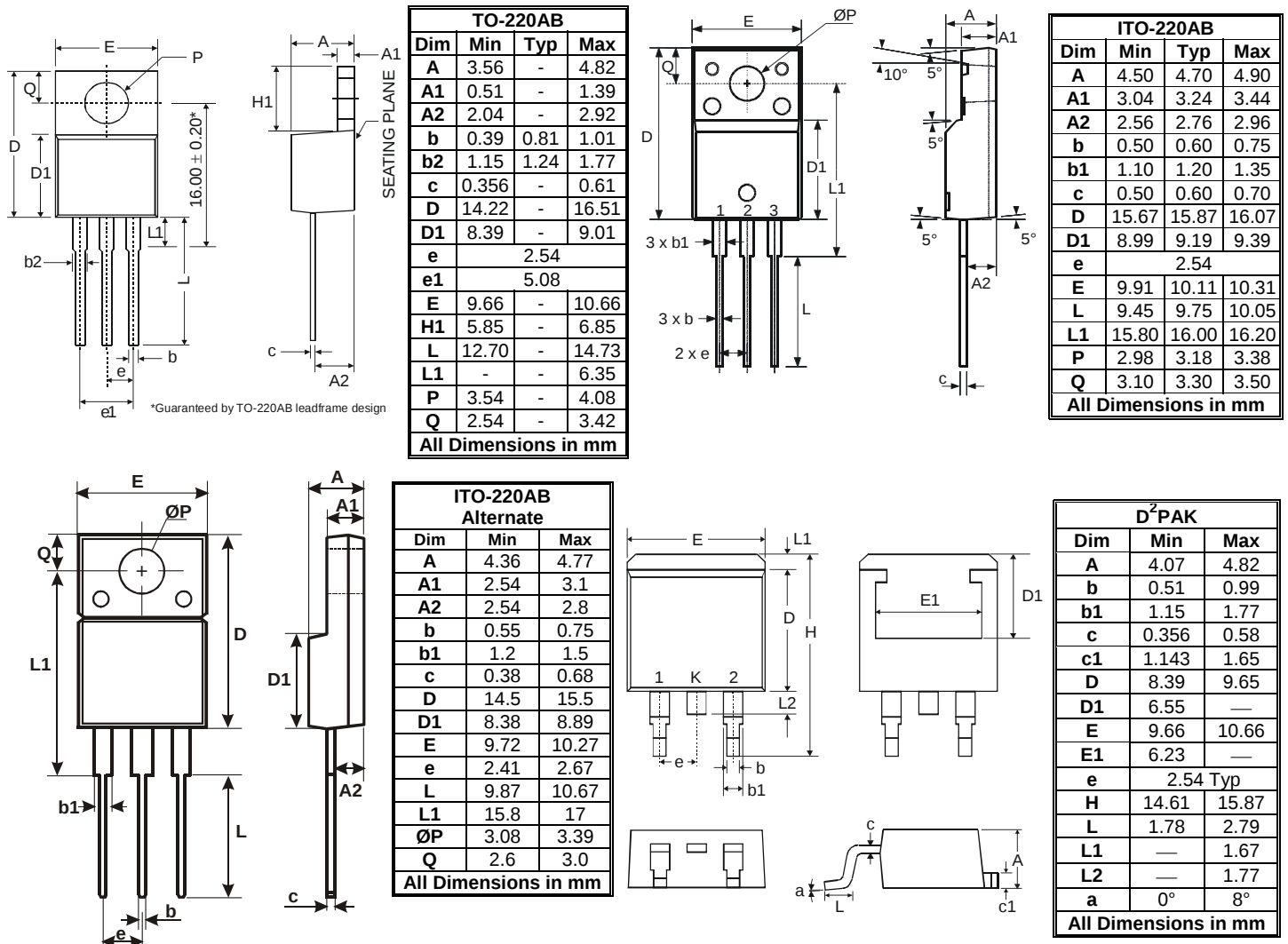
Electrical Characteristics (Per Leg) @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	-	- 0.60 -	0.82 0.65 0.88	V	I _F = 5A, T _J = 25°C I _F = 5A, T _J = 125°C I _F = 10A, T _J = 25°C
Leakage Current (Note 6)	I _R	-	-	0.2 25	mA	V _R = 200V, T _J = 25°C V _R = 200V, T _J = 125°C
Reverse Recovery Time	t _{rr}	-	24 20	30 25	ns	I _F = 0.5A, I _R = 1A, I _{RR} = 0.25A I _F = 1A, V _R = 30V, di/dt = 100A/μS, T _J = 25°C

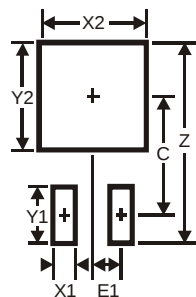
Notes: 6. Short duration pulse test used to minimize self-heating effect.
 7. Using heatsink (by Black Aluminum 45mm * 20mm * 12mm)



Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
Z	16.9
X1	1.1
X2	10.8
Y1	3.5
Y2	11.4
C	9.5
E1	2.5

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B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

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